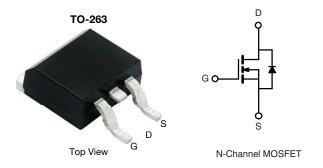


www.vishay.com

Vishay Siliconix

Automotive N-Channel 40 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	40				
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.0016				
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 \text{ V}$	0.0019				
I _D (A)	120				
Configuration	Single				



FEATURES

- TrenchFET® power MOSFET
- Package with low thermal resistance
- 100 % R_q and UIS tested
- AEC-Q101 qualified d
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



FREE

ORDERING INFORMATION				
Package	TO-263			
Lead (Pb)-free and Halogen-free	SQM40010EL-GE3			

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V_{DS}	40	V		
Gate-Source Voltage	V_{GS}	± 20	V		
Continuous Drain Current a	T _C = 25 °C		120		
Continuous Drain Current	T _C = 125 °C		120		
Continuous Source Current (Diode Conduction) a	I _S	120	Α		
Pulsed Drain Current ^b	I _{DM}	300			
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	80		
Single Pulse Avalanche Energy		E _{AS}	320	mJ	
Maximum Power Dissipation ^b	T _C = 25 °C	0	375	W	
Maximum i Owei Dissipation -	T _C = 125 °C	P _D 125		VV	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +175	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	LIMIT	UNIT		
Junction-to-Ambient	PCB Mount c	R_{thJA}	40	°C/W		
Junction-to-Case (Drain)		R _{thJC}	0.4	- C/VV		

Notes

- a. Package limited.
- b. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%.$
- c. When mounted on 1" square PCB (FR4 material).
- d. Parametric verification ongoing.



Vishay Siliconix

$ P_{DS(on)} = \begin{array}{c ccccccccccccccccccccccccccccccccccc$	TYP.	MIN. T	MAX.	UNIT
	I		l	ı
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	-	40	-	.,
	2.0	1.5 2	2.5	V
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	-	-	± 100	nA
$ V_{GS} = 0 \ V V_{DS} = 40 \ V, T_{J} = 175 \ ^{\circ}C - - - - - - - - - $	-	-	1	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	-	-	50	μA
Parameter Con-State Resistance a & Parameter Resistance a & Paramete	-	-	2	mA
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	-	120	-	Α
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	0.00121	- 0.00	1 0.00160	
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	-	-	0.00250	Ω
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	-		0.00280	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	0.00145	- 0.00	5 0.00190	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	174	- 1	-	S
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$				
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	13 630	- 13	17 100	pF
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	8660	- 86	10 900	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	1460	- 14	1900	
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	150	- 1	230	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	30	- 3	-	nC
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	12	- 1	-	
Rise Time $^{\circ}$ t_r $V_{DD} = 20 \text{ V}, \text{ R}_L = 0.2 \Omega$ $-$ Turn-Off Delay Time $^{\circ}$ $t_{d(off)}$ $I_D \cong 100 \text{ A}, \text{ V}_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$ $-$	1.62	0.8 1.	2.5	Ω
Turn-Off Delay Time $^{\circ}$ $t_{d(off)}$ $I_{D} \cong 100 \text{ A, } V_{GEN} = 10 \text{ V, } R_{g} = 1 \Omega$	14	- 1	25	
Turn on Boldy Time	20	- 2	30	
Fall Time ^c t _f -	60	- 6	90	ns
	14	- 1	25	1
Source-Drain Diode Ratings and Characteristics ^b				l .
Pulsed Current ^a I _{SM} -	-	-	300	Α
Forward Voltage V_{SD} $I_F = 70 \text{ A}, V_{GS} = 0 \text{ V}$ -	0.85	- 0.	1.5	V

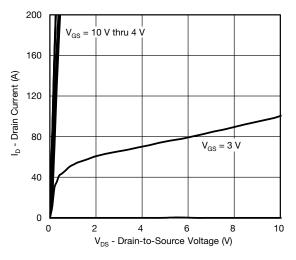
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

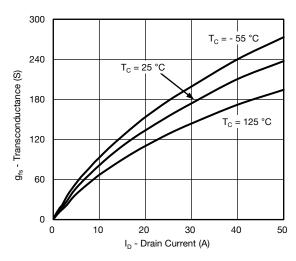
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



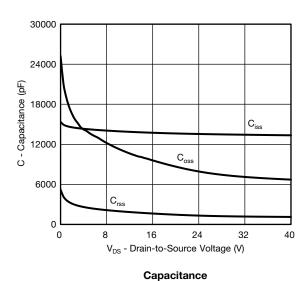
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



Output Characteristics



Transconductance

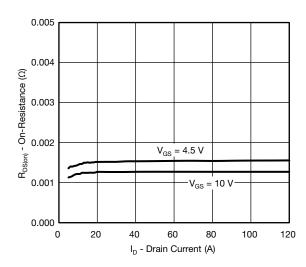


160

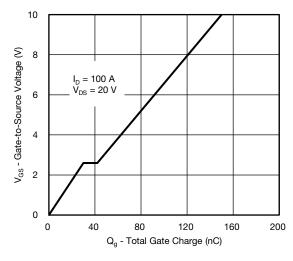
128

(x) the sum of the control of the control

Transfer Characteristics

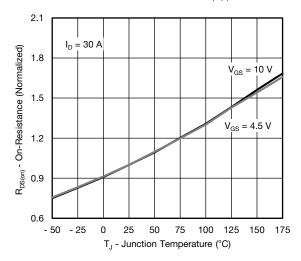


On-Resistance vs. Drain Current

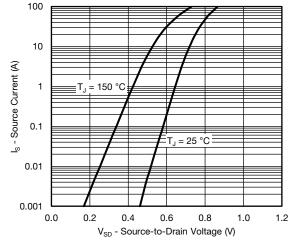




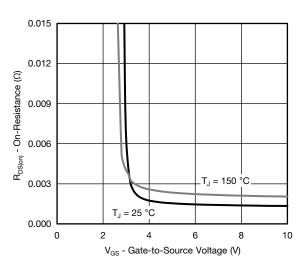
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



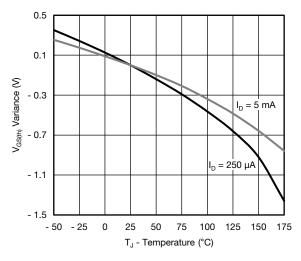
On-Resistance vs. Junction Temperature



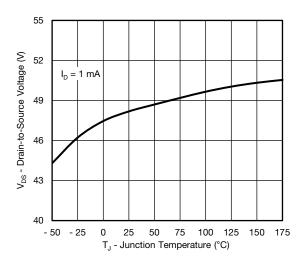
Source Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



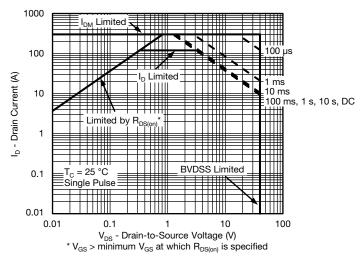
Threshold Voltage



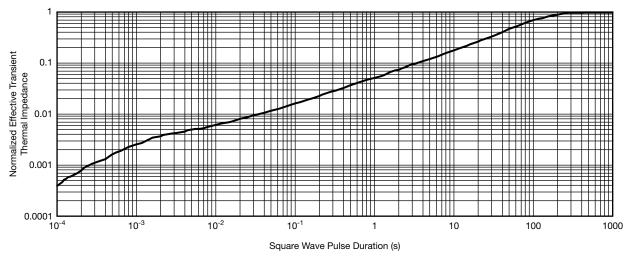
Drain Source Breakdown vs. Junction Temperature



THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



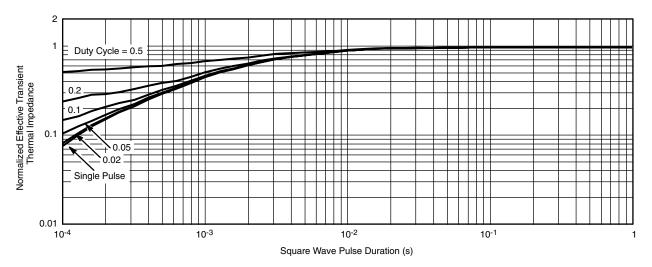
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?69430.



TO-263 (D²PAK): 3-LEAD









DETAIL A (ROTATED 90°)



⋝:	,	 	b— b1–		ļ	ļ
2:	П				5	ပ
	SE	СТ	ION	ΙΔ.	- 1 - Δ	Ŧ

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB. Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

6 This feature is for thick lead.

		INCHES		MILLIN	METERS	
DIM.		MIN.	MAX.	MIN.	MAX.	
	Α	0.160	0.190	4.064	4.826	
	b	0.020	0.039	0.508	0.990	
	b1	0.020	0.035	0.508	0.889	
	b2	0.045	0.055	1.143	1.397	
c*	Thin lead	0.013	0.018	0.330	0.457	
	Thick lead	0.023	0.028	0.584	0.711	
c1	Thin lead	0.013	0.017	0.330	0.431	
CI	Thick lead	0.023	0.027	0.584	0.685	
	c2	0.045	0.055	1.143	1.397	
	D	0.340	0.380	8.636	9.652	
	D1	0.220	0.240	5.588	6.096	
	D2	0.038	0.042	0.965	1.067	
D3		0.045	0.055	1.143	1.397	
	D4	0.044	0.052	1.118	1.321	
	Е	0.380	0.410	9.652	10.414	
	E1	0.245	-	6.223	-	
	E2	0.355	0.375	9.017	9.525	
	E3	0.072	0.078	1.829	1.981	
	е	0.100	BSC	2.54	BSC	
	K	0.045	0.055	1.143	1.397	
	L	0.575	0.625	14.605	15.875	
L1		0.090	0.110	2.286	2.794	
	L2	0.040	0.055	1.016	1.397	
	L3	0.050	0.070	1.270	1.778	
	L4	0.010 BSC		0.254	BSC	
М		-	0.002	-	0.050	
ECN: T13-0707-Rev. K, 30-Sep-13						

DWG: 5843





RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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